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June 2003

FDS6670A

FAIRCHILD SEMICONDUCTOR

Single N-Channel, Logic Level, PowerTrench[®] MOSFET

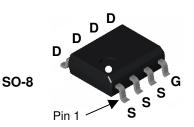
General Description

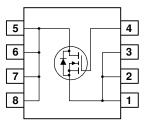
This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- 13 A, 30 V. $\begin{array}{l} R_{\text{DS}(\text{ON})} \ = 8 \ m\Omega \ @ \ V_{\text{GS}} = 10 \ V \\ R_{\text{DS}(\text{ON})} \ = 10 \ m\Omega \ @ \ V_{\text{GS}} = 4.5 \ V \end{array}$
- Fast switching speed
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source	Drain-Source Voltage		30	V	
V _{GSS}	Gate-Source	e Voltage		±20	V	
I _D	Drain Currer	nt – Continuous	(Note 1a)	13	А	
		– Pulsed		50		
PD	Power Dissi	pation for Single Operation	(Note 1a)	2.5	W	
			(Note 1b)	1.0		
T _J , T _{STG}	Operating an	nd Storage Junction Tempe	erature Range	-55 to +150	°C	
Therma	I Charact	eristics				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a		ent (Note 1a)	50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note			125		
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)			25		
Packag	e Marking	g and Ordering In	formation			
Device	Marking	Device	Reel Size	Tape width	Quantity	

	Device Marking	Device	Reel Size	Tape width	Quantity
-	FDS6670A	FDS6670A	13"	12mm	2500 units

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FDS6670A

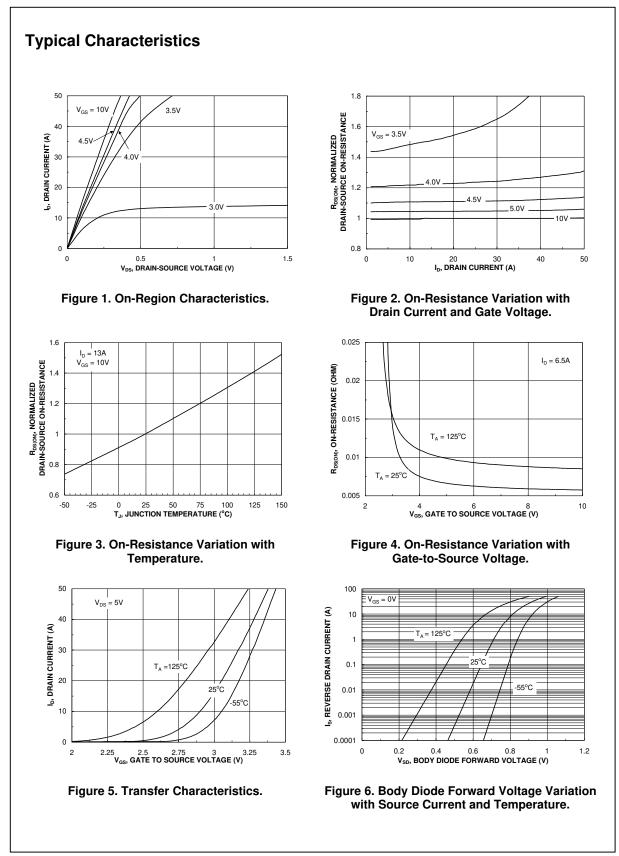
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
	Breakdown Voltage Temperature	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		26		mV/°C
ΔTJ I _{DSS}	Coefficient Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
033		$V_{DS} = 24 V, V_{GS} = 0 V, T_{J} = 55^{\circ}C$			10	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 250 \; \mu\text{A}$	1	1.8	3	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C			0	
ΔT_{J}	Temperature Coefficient			-5.3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$		6	8	mΩ
	On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 10.5 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}, T_J = 125^{\circ}\text{C}$		7.2 8.5	10 14	
1	On–State Drain Current	$V_{GS} = 10 \text{ V}, \text{ ID} = 13 \text{ A}, \text{ IJ} = 123 \text{ C}$ $V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 5 \text{ V}$	50	0.5	17	A
l _{D(on)} g _{FS}	Forward Transconductance	$V_{GS} = 10 V$, $V_{DS} = 3 V$ $V_{DS} = 15 V$, $I_D = 13 A$	50	55		S
				00		0
	Characteristics		1	0000		
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		2220		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		535		рF
C _{rss} R _G	Reverse Transfer Capacitance Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		200 1.7		pF Ω
		$V_{\rm GS} = 13$ mV, $T = 1.0$ MHZ		1.7		52
	g Characteristics (Note 2)		1			1
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$, $V_{GS} = 10 V$, $R_{GEN} = 6 Ω$		11	19	ns
tr	Turn–On Rise Time	$v_{GS} = 10 v$, $n_{GEN} = 0.52$		13	24	ns
t _{d(off)}	Turn–Off Delay Time			40	64	ns
t _f	Turn–Off Fall Time			13	24	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, I_D = 13 \text{ A}, \\ V_{GS} = 5 \text{ V}$		21	30	nC
Q _{gs}	Gate–Source Charge	$\nabla_{GS} = 3 \nabla$		6		nC
Q _{gd}	Gate-Drain Charge			7		nC
Drain-So	ource Diode Characteristics			1		
ls	Maximum Continuous Drain-Source	Diode Forward Current			2.1	A
V _{SD}	Drain–Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \qquad \ \ I_{\rm S} = 2.1 \ A \ ({\rm Note} \ 2)$		0.7	1.2	V
t _{rr}	Diode Reverse Recovery Time			31		nS
Q _{rr}	Diode Reverse Recovery Charge	$I_F = 13 \text{ A}, \qquad d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		21		nC

Scale 1 : 1 on letter size paper

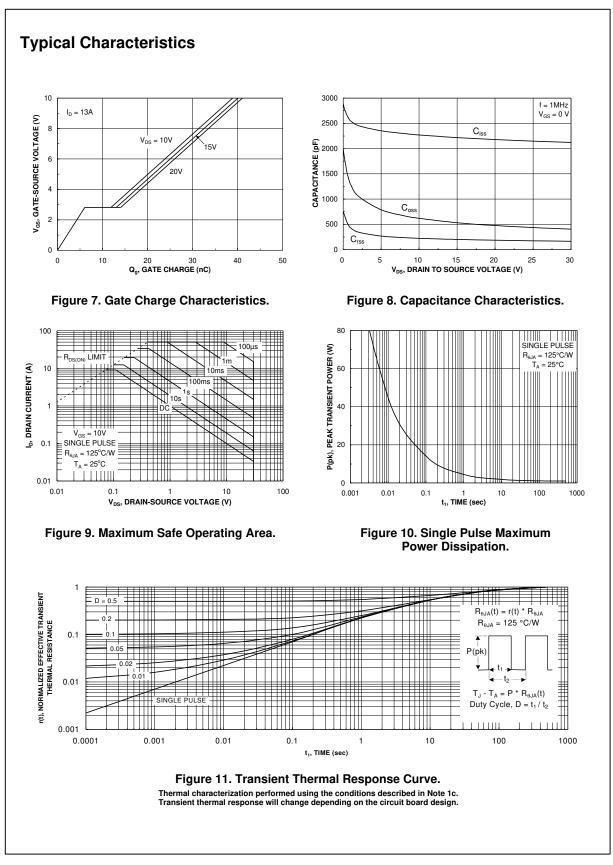
on a 1in² pad of 2 oz copper

2 Test: Pulse Width < 300μs, Duty Cycle < 2.0%

FDS6670A Rev F (W)



FDS6670A



FDS6670A

FDS6670A Rev F (W)

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